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	Form PTO-1595 RECORDATION (Rev. 10/02)		ARTMENT OF COMMERCE
	OMB No. 0651-0027 (exp. 6/30/2005)		Patent and Trademark Office
	Tab settings ⇔⇔ ♥ ▼	102944796	▼ ▼
	To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.		
	Name of conveying party(ies):	2. Name and address of receiving party(ies)	
	Chen-Nan Yeh	Name: Taiwan Semiconductor Manufacturing Co., Ltd.	
	Miao-Ju Hsu	ρ	
	Hun-Jan Tao	Internal Address:	——————————————————————————————————————
	Additional name(s) of conveying party(ies) attached? Yes No		3.0 2.0 2.0 2.0 3.0 3.0 3.0 3.0 3.0 3.0 3.0 3.0 3.0 3
	3. Nature of conveyance:		112963 11705,
	✓ Assignment Merger		- <del>2</del> -
		Street Address: No. 8, Li-Hsi	n Road 6
	Security Agreement Change of Name	Science Board Industrial De	_ ul-
	Other	Science-Based Industrial Pa	ark
		city: Hsin-Chu stat	re· Zip·
	-    -	Country: Taiwan, 300-77 R.O.	
C	Execution Date: 01/31/2005	Additional name(s) & address(es) at	ttached? Yes 🗸 No
•	4. Application number(s) or patent number(s):		
, V	If this document is being filed together with a new application, the execution date of the application is: 01/31/200		
ζ	A. Patent Application No.(s) B. Patent No.(s)		
	Additional numbers attached? Yes No		
	<ol><li>Name and address of party to whom correspondence concerning document should be mailed:</li></ol>	6. Total number of applications a	and patents involved:
	Name: William H. Murray	7. Total fee (37 CFR 3.41)	\$_40.00
		Enclosed	
	Internal Address:		
		Authorized to be charged to deposit account	
		8. Deposit account number:	
	Street Address: Duane Morris LLP	04.4070	
	One Liberty Place	04-1679	
	City: Philadelphia State: PA Zip: 19103-7396		
	DO NOT USE THIS SPACE		
	9. Signature.		
	Steven E. Koffs	wu 4./10/11	February 8, 2005
	Name of Ferson Signing	Signature	Date 5⁻₃
L	Total number of pages including cover	sheet, attachments, and documents:	<u> </u>

Mail documents to be recorded with required cover sheet information to:

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Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

EXPRESS MAIL LABEL NO. EV 516214815 US

ATTORNEY DOCKET NO.: 2004.0651/1085.00322

## ASSIGNMENT AND AGREEMENT

For value received, we, Chen-Nan Yeh, Miao-Ju Hsu, and Hun-Jan Tao hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to POST ETCH COPPER CLEANING USING DRY PLASMA described in an application for Letters Patent of the United States and all the rights and privileges in said applications and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

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1

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We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1

Dated: 1/31/2005

Chen-Nan Yeh

Residence: 172 Ming-Feng Street, Hsi-Chih, Taipei County, Taiwan, R.O.C.

Inventor No. 2

Dated: Yal (2005

Miao-Ju Hsu

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Inventor No. 3

Dated: 1/31/2005

RECORDED: 02/08/2005

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